505747057 10/29/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT5793870

SUBMISSION TYPE:	NEW ASSIGNMENT
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NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KYLE K. KIRBY	10/30/2017

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.	
Street Address:	8000 S. FEDERAL WAY	
City:	BOISE	
State/Country:	IDAHO	
Postal Code:	83716	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16667360

CORRESPONDENCE DATA

Fax Number: (208)562-4901

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2085624900

Email: instructions@parsonsbehle.com

Correspondent Name: PARSONS BEHLE & LATIMER - MICRON MICRON

Address Line 1: 800 W. MAIN STREET

Address Line 2: **SUITE 1300**

Address Line 4: BOISE, IDAHO 83702

ATTORNEY DOCKET NUMBER:	05847.049US02
NAME OF SUBMITTER:	JAMES D. MEADERS
SIGNATURE:	/James D. Meaders/
DATE SIGNED:	10/29/2019

Total Attachments: 2

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PATENT REEL: 050855 FRAME: 0068 505747057

PATENT APPLICATION ASSIGNMENT

WHEREAS, I, Kyle K. Kirby, residing in Eagle, Idaho, USA has invented new and useful

improvements in 3DI Solder Cup for which Assignor is making or has made application for

LETTERS PATENT OF THE UNITED STATES, which application has been duly executed by

Assignor concurrently herewith;

WHEREAS, Micron Technology, Inc., a corporation organized and existing under and by

virtue of the laws of the State of Delaware, and having an office and place of business at 8000 S.

Federal Way, Boise, Idaho 83716 USA, (hereinafter "Assignee") is desirous of acquiring our

entire right, title and interest in said application and our Letters Patent which may issue thereon.

NOW, THEREFORE, it be known by all whom it may concern that for and in consideration

of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and other good and valuable

consideration, I hereby assign to said corporation, both in and for the territory of the United States

of America and the entire world, all our title and interest in and to said invention, patent application

and any patent which may issue thereon, including all divisions, continuations, reissues,

continuations-in-part and substitutions thereof, plus all priority rights for patent applications

foreign to the United States of America. I further hereby assign and transfer to said corporation

whatever cause of action I may have for past or present infringement of said invention, together

with the right to bring suit for any such infringement and to seek and receive damages and other

relief arising from any such infringement.

I HEREBY covenant and agree that I will at any time, upon the request of said corporation,

execute and deliver any and all papers and do all lawful acts that may be necessary or desirable to

perfect the title to said invention, applications and patents, and I authorize the Commissioner of

Patents and Trademarks to issue Letters patent to said corporation.

PATENT REEL: 050855 FRAME: 0069 Inventor 1

KYLE K. KARBY

_Date:

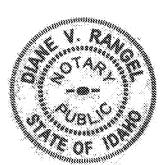
STATE OF

\$5.

COUNTY OF

This 30 day of 00 folder, 2017 before me personally came the above-named, Kyle K. Kirby, to me personally known as the individual who executed the foregoing assignment, who acknowledged to me that he/she executed the same of his/her own free will for the purposes therein set forth.

Seal



(Notary Public

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